

**POLYBATCH® CE 505**

**POLYBATCH® CE 505** is a slip masterbatch to be used in combination with antiblock masterbatch, such as POLYBATCH® AB 5, F 15, LCC 50, SAS or with resins that already contain antiblock agents.

**POLYBATCH® CE 505** allows the processor to formulate his films according to the exact requirements of the converter and/or end-users.

**PHYSICAL PROPERTIES**

Base resin	PE
Melt Index (190/2,16; g/10 min)	19
Specific Gravity (g/cm <sup>3</sup> )	0.93
Bulk Density (g/l)	600
Moisture Content (ppm)	< 1500
Oleamide (%)	5

These are typical properties only, and are not be regarded as sales specifications.

**USAGE**

**POLYBATCH® CE 505** should be used for applications, where the processing temperature does not exceed 230°C.

Recommended let-down ratios , depending on desired SLIP level:

from 1 to 4% of **POLYBATCH® CE 505**

Used at normal let-down ratios all **POLYBATCH®** slip masterbatches have negligible influence on Corona treatment, sealability and glueing properties. However their combined effect with other migrating additives, such as antistatic agents or UV-stabilisers must be carefully evaluated.

**FOOD APPROVAL**

**POLYBATCH® CE 505** can be used for food-packaging according to:

FDA	no limitation
EEC (90/128)	no limitation

Detailed information available upon request.

**PACKAGING AND STORAGE**

**POLYBATCH® CE 505** is packed in 25 kg Polyethylene bags on shrink wrapped pallets. Storage should not exceed 6 months, as decreased slip properties, rancid odours or a brownish colour can develop.

Users should undertake sufficient verification and testing to determine the suitability for their own purpose of any information or products referred to herein.

Reported values pertain only to natural resins : pigmenting may vary properties.

NOTE : While the information herein is believed to be reliable and correct, nothing herein is intended and should not be construed as a representation or warranty, expressed or implied, as to results obtained or to be obtained by others who may make use of this information or with respect to the absence, existence or validity of patent rights, if any of others involving any composition or process herein referred to ; or an inducement or recommendation for the violation of any such patent rights; and responsibility and liability therefore is disclaimed.